

**RoHS** 

COMPLIANT HALOGEN

FREE

# SI2302DDS-T1-GE3-VB Datasheet

Single-N Trench SOT23-3 20V MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>e</sup>	Q <sub>g</sub> (Typ.)			
	0.028 at V <sub>GS</sub> = 4.5 V	6 <sup>a</sup>				
20	0.042 at V <sub>GS</sub> = 2.5 V	<sub>GS</sub> = 2.5 V 6 <sup>a</sup> 8				
	0.050 at V <sub>GS</sub> = 1.8 V	5.6				



- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 %  $\rm R_g$  Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- DC/DC Converters
- Load Switch for Portable Applications

<b>ABSOLUTE MAXIMUM RATINGS</b> T <sub>A</sub> = 25 °C, unless otherwise noted								
Parameter		Symbol	Limit	Unit				
Drain-Source Voltage		V <sub>DS</sub>	20	V				
Gate-Source Voltage	Gate-Source Voltage		± 12	V				
	T <sub>C</sub> = 25 °C		6 <sup>a</sup>	A				
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C	- I <sub>D</sub>	5.1					
Continuous Drain Current $(T_j = 150 \text{ C})$	T <sub>A</sub> = 25 °C		5 <sup>b, c</sup>					
	T <sub>A</sub> = 70 °C	1	4 <sup>b, c</sup>					
Pulsed Drain Current		I <sub>DM</sub>	20	1				
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	-	1.75					
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	1.04 <sup>b, c</sup>					
	T <sub>C</sub> = 25 °C		2.1	ĺ				
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C	P <sub>D</sub>	1.3	w				
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		1.25 <sup>b, c</sup>					
	T <sub>A</sub> = 70 °C	1	0.8 <sup>b, c</sup>					
Operating Junction and Storage Temperature	Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C				
Soldering Recommendations (Peak Tempera	ature)	, in the second se	260					

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	80	100	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	40	60	]		

Notes:

- a. Package limited
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 125  $^{\circ}\text{C/W}.$
- e. Based on T<sub>C</sub> = 25 °C.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					1		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L _ 250A		25		m\//°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 2.6		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.45		1.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current	DSS	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 70 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5$ V, $V_{GS}$ = 4.5 V	20			A	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 5.0 \text{ A}$		0.028		Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, I_{D} = 4.7 \text{ A}$		0.042			
		$V_{GS} = 1.8 \text{ V}, I_D = 4.3 \text{ A}$		0.050		1	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5.0 A		24		S	
Dynamic <sup>b</sup>	1					1	
Input Capacitance	C <sub>iss</sub>			865		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		105			
Reverse Transfer Capacitance	C <sub>rss</sub>			55			
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 5.0 \text{ A}$		12	18		
				8.8	14	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5.0 \text{ A}$		1.1			
Gate-Drain Charge	Q <sub>gd</sub>			0.7			
Gate Resistance	Rg	f = 1 MHz	0.5	2.4	4.8	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			8	16	ns	
Rise Time	tr	$V_{DD}$ = 10 V, $R_L$ = 2.2 $\Omega$		17	26		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong \text{4}$ A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		31	47		
Fall Time	t <sub>f</sub>			8	16		
Turn-On Delay Time	t <sub>d(on)</sub>			5	10		
Rise Time	tr	$V_{DD}$ = 10 V, $R_L$ = 2.2 $\Omega$		13	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	${\rm I}_{\rm D}{\cong}4$ A, ${\rm V}_{\rm GEN}$ = 5 V, ${\rm R}_{\rm g}$ = 1 $\Omega$		21	32		
Fall Time	t <sub>f</sub>			6	12		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	T <sub>C</sub> = 25 °C			1.75		
Pulse Diode Forward Current	I <sub>SM</sub>				20	- A	
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = 4 A, V_{GS} = 0 V$		0.75	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			12	20	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			5	10	nC	
Reverse Recovery Fall Time	ta	$I_F = 4 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		7			
Reverse Recovery Rise Time	t <sub>b</sub>			5		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Gate Charge



On-Resistance vs. Junction Temperature



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





### SOT-23 (TO-236): 3-LEAD



Dim	MILLIN	IETERS	INCHES		
	Min	Мах	Min	Max	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09-Jul-01 DWG: 5479					



#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)



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